

October 2011

2N3906 / MMBT3906 / PZT3906 PNP General Purpose Amplifier

Features

This device is designed for general purpose amplifier and switching applications at collector currents of 10μA to 100 mA



Absolute Maximum Ratings* T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	-40	V
V_{CBO}	Collector-Base Voltage	-40	V
V_{EBO}	Emitter-Base Voltage	-5.0	V
I _C	Collector Current - Continuous	-200	mA
T _{J,} T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics $T_a = 25^{\circ}$ C unless otherwise noted

Symbol	Parameter	Max.			Units
		2N3906	*MMBT3906	**PZT3906	Uiilla
P _D	Total Device Dissipation Derate above 25°C	625 5.0	350 2.8	1,000 8.0	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3			°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	200	357	125	°C/W

^{*} Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06".

¹⁾ These ratings are based on a maximum junction temperature of 150 degrees C.

²⁾ These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

^{**} Device mounted on FR-4 PCB 36 mm X 18 mm X 1.5 mm; mounting pad for the collector lead min. 6 cm 2 .

Electrical Characteristics $T_a = 25$ °C unless otherwise noted

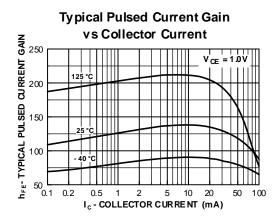
Symbol	Parameter	Test Condition	Min.	Max.	Units
OFF CHARAC	CTERISTICS	1			
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage*	$I_C = -1.0 \text{mA}, I_B = 0$	-40		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = -10\mu A, I_E = 0$	-40		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = -10\mu A, I_C = 0$	-5.0		V
I _{BL}	Base Cutoff Current	$V_{CE} = -30V, V_{BE} = -3.0V$		-50	nA
I _{CEX}	Collector Cutoff Current	$V_{CE} = -30V, V_{BE} = -3.0V$		-50	nA
ON CHARAC	TERISTICS	1			•
h _{FE}	DC Current Gain*	$\begin{split} & I_{C} = \text{-0.1mA}, \ V_{CE} = \text{-1.0V} \\ & I_{C} = \text{-1.0mA}, \ V_{CE} = \text{-1.0V} \\ & I_{C} = \text{-10mA}, \ V_{CE} = \text{-1.0V} \\ & I_{C} = \text{-50mA}, \ V_{CE} = \text{-1.0V} \\ & I_{C} = \text{-100mA}, \ V_{CE} = \text{-1.0V} \\ \end{split}$	60 80 100 60 30	300	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = -10mA, I _B = -1.0mA I _C = -50mA, I _B = -5.0mA		-0.25 -0.4	V V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = -10 \text{mA}, I_B = -1.0 \text{mA}$ $I_C = -50 \text{mA}, I_B = -5.0 \text{mA}$	-0.65	-0.85 -0.95	V V
SMALL SIGN	AL CHARACTERISTICS				
f _T	Current Gain - Bandwidth Product	ct $I_C = -10 \text{mA}, V_{CE} = -20 \text{V},$ 250 $f = 100 \text{MHz}$			MHz
C _{obo}	Output Capacitance	$V_{CB} = -5.0V, I_{E} = 0,$ f = 100kHz		4.5	pF
C _{ibo}	Input Capacitance	$V_{EB} = -0.5V, I_{C} = 0,$ f = 100kHz		10.0	pF
NF	Noise Figure	I_{C} = -100 μ A, V_{CE} = -5.0V, R_{S} = 1.0k Ω , f = 10Hz to 15.7kHz		4.0	dB
SWITCHING (CHARACTERISTICS	<u> </u>		•	•
t _d	Delay Time	$V_{CC} = -3.0V, V_{BE} = -0.5V$		35	ns
t _r	Rise Time	$I_C = -10 \text{mA}, I_{B1} = -1.0 \text{mA}$		35	ns
t _s	Storage Time	$V_{CC} = -3.0V, I_{C} = -10mA,$		225	ns
t _f	Fall Time	$I_{B1} = I_{B2} = -1.0 \text{mA}$		75	ns

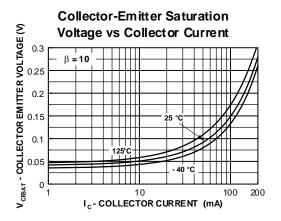
^{*} Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%

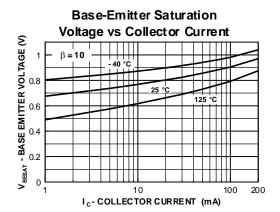
Ordering Information

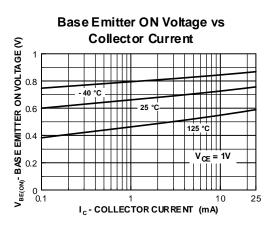
Part Number	Marking	Package	Packing Method	Pack Qty
2N3906BU	2N3906	TO-92	BULK	10000
2N3906TA	2N3906	TO-92	AMMO	2000
2N3906TAR	2N3906	TO-92	AMMO	2000
2N3906TF	2N3906	TO-92	TAPE REEL	2000
2N3906TFR	2N3906	TO-92	TAPE REEL	2000
MMBT3906	2A	SOT-23	TAPE REEL	3000
PZT3906	3906	SOT-223	TAPE REEL	2500

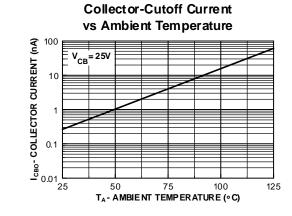
Typical Performance Characteristics

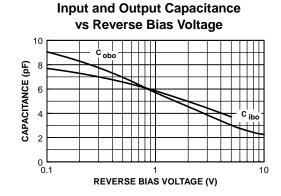






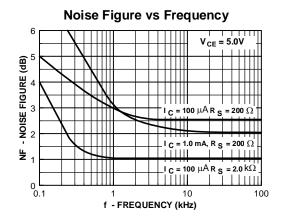


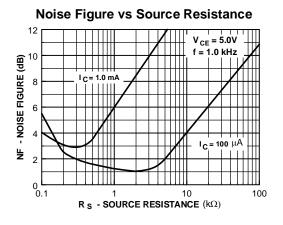


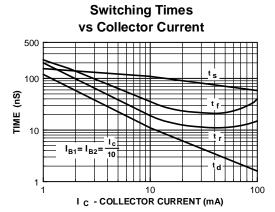


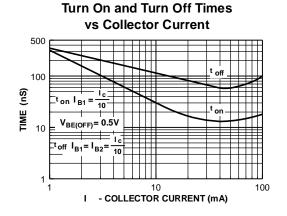
Common-Base Open Circuit

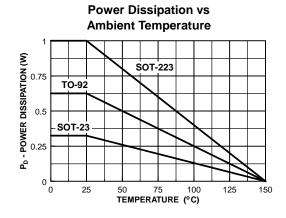
Typical Performance Characteristics (continued)



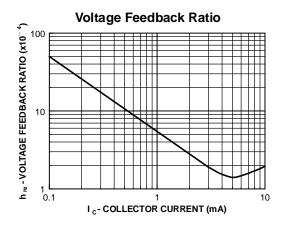


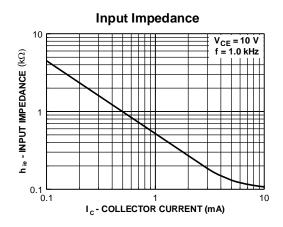


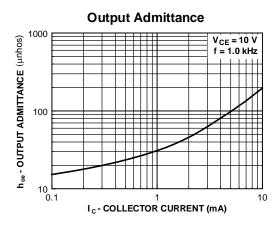


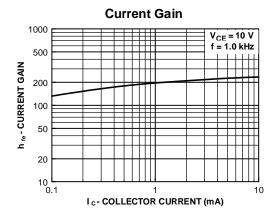


Typical Performance Characteristics (continued)













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